National Semiconductor

February 1988

MM54C00/MM74C00 Quad 2-Input NAND Gate
MM54C02/MM74C02 Quad 2-Input NOR Gate
MM54C04/MM74C04 Hex Inverter
MM54C10/MM74C10 Triple 3-Input NAND Gate
MM54C20/MM74C20 Dual 4-Input NAND Gate

General Description

These logic gates employ complementary MOS (CMOS) to achieve wide power supply operating range, low power consumption, high noise immunity and symmetric controlled rise and fall times. With features such as this the 54C/74C logic family is close to ideal for use in digital systems. Function and pin out compatibility with series 54/74 devices minimizes design time for those designers already familiar with the standard 54/74 logic family.

All inputs are protected from damage due to static discharge by diode clamps to V_{CC} and GND.

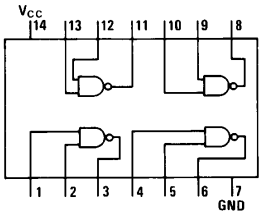
Features

■ Wide supply voltage range	3V to 15V
■ Guaranteed noise margin	1V
■ High noise immunity	0.45 V_{CC} (typ.)
■ Low power consumption	10 nW/package (typ.)
■ Low power TTL compatibility	Fan out of 2 driving 74L

Connection Diagrams

Dual-In-Line Packages

MM54C00/MM74C00

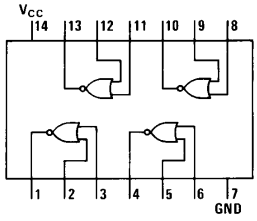


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Top View

Order Number MM54C00 or MM74C00

MM54C02/MM74C02

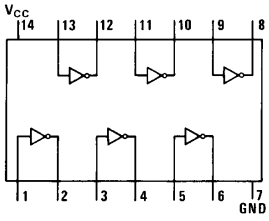


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Top View

Order Number MM54C02 or MM74C02

MM54C04/MM74C04

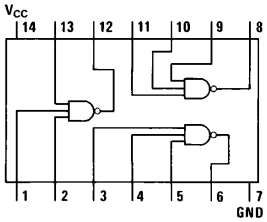


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Top View

Order Number MM54C04 or MM74C04

MM54C10/MM74C10

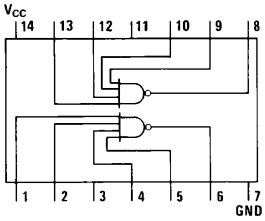


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Top View

Order Number MM54C10 or MM74C10

MM54C20/MM74C20



TL/F/5877–5

Top View

Order Number MM54C20 or MM74C20

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Absolute Maximum Ratings

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Voltage at Any Pin	$-0.3V$ to $V_{CC} + 0.3V$
Operating Temperature Range	
54C	$-55°C$ to $+125°C$
74C	$-40°C$ to $+85°C$
Storage Temperature Range	$-65°C$ to $+150°C$
Operating V_{CC} Range	3.0V to 15V
Maximum V_{CC} Voltage	18V
Power Dissipation (P_D)	
Dual-In-Line	700 mW
Small Outline	500 mW
Lead Temperature (Soldering, 10 seconds)	300°C

DC Electrical Characteristics

Min/Max limits apply across the guaranteed temperature range unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units
CMOS TO CMOS						
$V_{IN(1)}$	Logical "1" Input Voltage	$V_{CC} = 5.0V$	3.5			V
		$V_{CC} = 10V$	8.0			V
$V_{IN(0)}$	Logical "0" Input Voltage	$V_{CC} = 5.0V$			1.5	V
		$V_{CC} = 10V$			2.0	V
$V_{OUT(1)}$	Logical "1" Output Voltage	$V_{CC} = 5.0V$, $I_O = -10\ \mu A$	4.5			V
		$V_{CC} = 10V$, $I_O = -10\ \mu A$	9.0			V
$V_{OUT(0)}$	Logical "0" Output Voltage	$V_{CC} = 5.0V$, $I_O = 10\ \mu A$			0.5	V
		$V_{CC} = 10V$, $I_O = 10\ \mu A$			1.0	V
$I_{IN(1)}$	Logical "1" Input Current	$V_{CC} = 15V$, $V_{IN} = 15V$		0.005	1.0	μA
$I_{IN(0)}$	Logical "0" Input Current	$V_{CC} = 15V$, $V_{IN} = 0V$	-1.0	-0.005		μA
I_{CC}	Supply Current	$V_{CC} = 15V$		0.01	15	μA
LOW POWER TO CMOS						
$V_{IN(1)}$	Logical "1" Input Voltage	54C, $V_{CC} = 4.5V$	$V_{CC} - 1.5$			V
		74C, $V_{CC} = 4.75V$	$V_{CC} - 1.5$			V
$V_{IN(0)}$	Logical "0" Input Voltage	54C, $V_{CC} = 4.5V$			0.8	V
		74C, $V_{CC} = 4.75V$			0.8	V
$V_{OUT(1)}$	Logical "1" Output Voltage	54C, $V_{CC} = 4.5V$, $I_O = -10\ \mu A$	4.4			V
		74C, $V_{CC} = 4.75V$, $I_O = -10\ \mu A$	4.4			V
$V_{OUT(0)}$	Logical "0" Output Voltage	54C, $V_{CC} = 4.5V$, $I_O = 10\ \mu A$			0.4	V
		74C, $V_{CC} = 4.75V$, $I_O = 10\ \mu A$			0.4	V
CMOS TO LOW POWER						
$V_{IN(1)}$	Logical "1" Input Voltage	54C, $V_{CC} = 4.5V$	4.0			V
		74C, $V_{CC} = 4.75V$	4.0			V
$V_{IN(0)}$	Logical "0" Input Voltage	54C, $V_{CC} = 4.5V$			1.0	V
		74C, $V_{CC} = 4.75V$			1.0	V
$V_{OUT(1)}$	Logical "1" Output Voltage	54C, $V_{CC} = 4.5V$, $I_O = -360\ \mu A$	2.4			V
		74C, $V_{CC} = 4.75V$, $I_O = -360\ \mu A$	2.4			V
$V_{OUT(0)}$	Logical "0" Output Voltage	54C, $V_{CC} = 4.5V$, $I_O = 360\ \mu A$			0.4	V
		74C, $V_{CC} = 4.75V$, $I_O = 360\ \mu A$			0.4	V
OUTPUT DRIVE (see 54C/74C Family Characteristics Data Sheet) $T_A = 25°C$ (short circuit current)						
I_{SOURCE}	Output Source Current	$V_{CC} = 5.0V$, $V_{IN(0)} = 0V$, $V_{OUT} = 0V$	-1.75			mA
I_{SOURCE}	Output Source Current	$V_{CC} = 10V$, $V_{IN(0)} = 0V$, $V_{OUT} = 0V$	-8.0			mA
I_{SINK}	Output Sink Current	$V_{CC} = 5.0V$, $V_{IN(1)} = 5.0V$, $V_{OUT} = V_{CC}$	1.75			mA
I_{SINK}	Output Sink Current	$V_{CC} = 10V$, $V_{IN(1)} = 10V$, $V_{OUT} = V_{CC}$	8.0			mA

AC Electrical Characteristics* $T_A = 25°C$, $C_L = 50$ pF, unless otherwise specified

Symbol	Parameter	Conditions	Min	Typ	Max	Units
MM54C00/MM74C00, MM54C02/MM74C02, MM54C04/MM74C04						
t_{pd0}, t_{pd1}	Propagation Delay Time to Logical "1" or "0"	$V_{CC} = 5.0V$		50	90	ns
		$V_{CC} = 10V$		30	60	ns
C_{IN}	Input Capacitance	(Note 2)		6.0		pF
C_{PD}	Power Dissipation Capacitance	(Note 3) Per Gate or Inverter		12		pF
MM54C10/MM74C10						
t_{pd0}, t_{pd1}	Propagation Delay Time to Logical "1" or "0"	$V_{CC} = 5.0V$		60	100	ns
		$V_{CC} = 10V$		35	70	ns
C_{IN}	Input Capacitance	(Note 2)		7.0		pF
C_{PD}	Power Dissipation Capacitance	(Note 3) Per Gate		18		pF
MM54C20/MM74C20						
t_{pd0}, t_{pd1}	Propagation Delay Time to Logical "1" or "0"	$V_{CC} = 5.0V$		70	115	ns
		$V_{CC} = 10V$		40	80	ns
C_{IN}	Input Capacitance	(Note 2)		9		pF
C_{PD}	Power Dissipation Capacitance	(Note 3) Per Gate		30		pF

*AC Parameters are guaranteed by DC correlated testing.

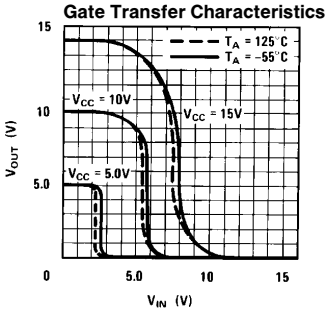
Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. Except for "Operating Temperature Range" they are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

Note 2: Capacitance is guaranteed by periodic testing.

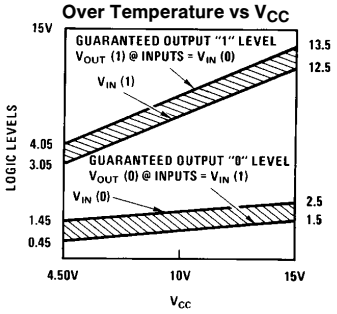
Note 3: C_{PD} determines the no load AC power consumption of any CMOS device. For complete explanation see 54C/74C Family Characteristics Application Note—AN-90.

Typical Performance Characteristics

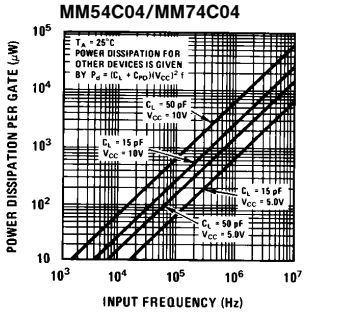
Gate Transfer Characteristics



Guaranteed Noise Margin Over Temperature vs V_{CC}



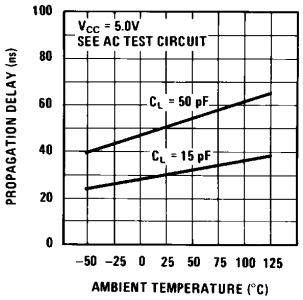
Power Dissipation vs Frequency MM54C00/MM74C00, MM54C02/MM74C02, MM54C04/MM74C04



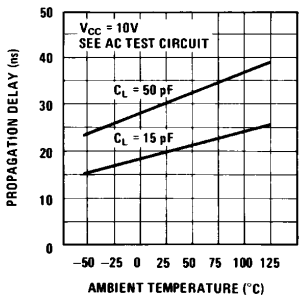
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Typical Performance Characteristics (Continued)

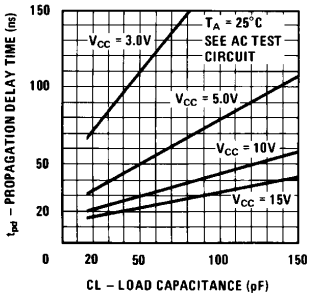
Propagation Delay vs Ambient Temperature MM54C00/MM74C00, MM54C02/MM74C02, MM54C04/MM74C04



Propagation Delay vs Ambient Temperature MM54C00/MM74C00, MM54C02/MM74C02, MM54C04/MM74C04

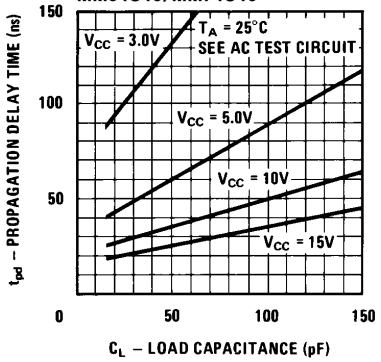


Propagation Delay Time vs Load Capacitance MM54C00/MM74C00, MM54C02/MM74C02, MM54C04/MM74C04



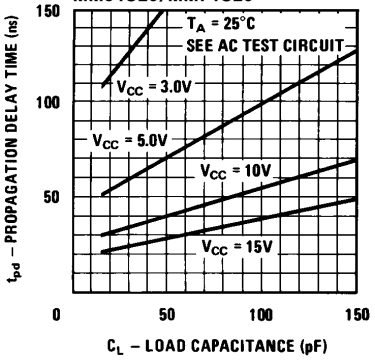
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Propagation Delay Time vs Load Capacitance MM54C10/MM74C10



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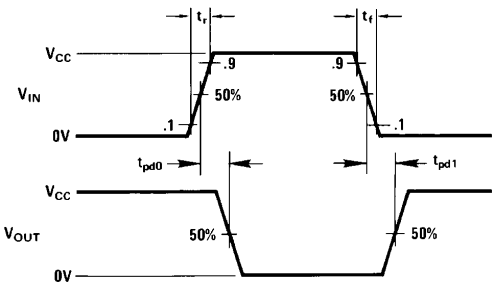
Propagation Delay Time vs Load Capacitance MM54C20/MM74C20



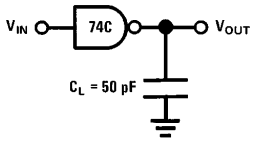
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Switching Time Waveforms and AC Test Circuit

CMOS to CMOS



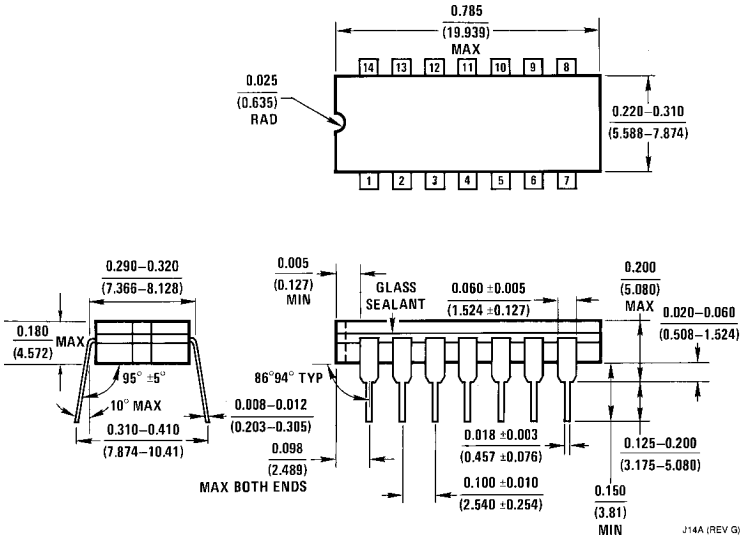
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TL/F/5877–11

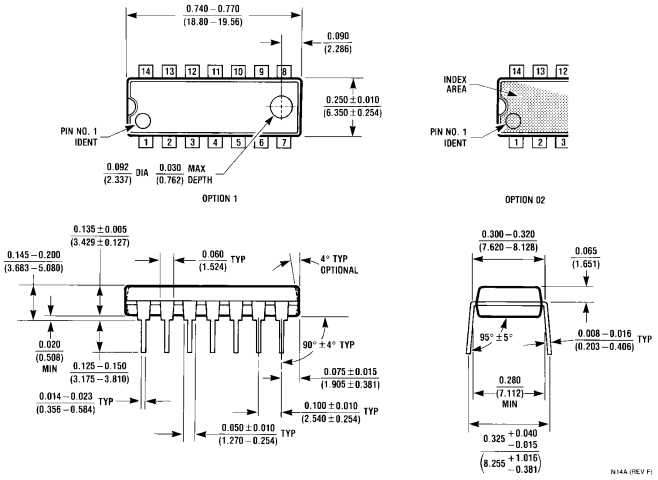
Note: Delays measured with input t_r, $t_f \leq 20$ ns.

Physical Dimensions inches (millimeters)



Ceramic Dual-In-Line Package (J)
Order Number MM54C00J, MM54C02J, MM54C04J, MM54C10J, MM54C20J, MM74C00J, MM74C02J, MM74C04J, MM74C10J or MM74C20J
NS Package Number J14A

Physical Dimensions inches (millimeters) (Continued)



Molded Dual-In-Line Package (N)
Order Number MM54C00N, MM54C02N, MM54C04N, MM54C10N, MM54C20N, MM74C00N, MM74C02N, MM74C04N, MM74C10N or MM74C20N
NS Package Number N14A

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